

## FDD390N15A N-Channel PowerTrench<sup>®</sup> MOSFET 150 V, 26 A, 40 m $\Omega$

### Features

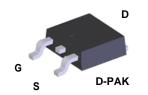
- $R_{DS(on)} = 33.5 \text{ m}\Omega \text{ (Typ.)} \otimes V_{GS} = 10 \text{ V}, I_D = 26 \text{ A}$
- Fast Switching Speed
- Low Gate Charge, Q<sub>G</sub> = 14.3 nC( Typ.)
- High Performance Trench Technology for Extremely Low  $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

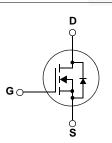
### Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

### Applications

- Consumer Appliances
- LED TV
- Synchronous Rectification
- Uninterruptible Power Supply
- Micro Solar Inverter





### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol		Parameter		FDD390N15A	Unit	
V <sub>DSS</sub>	Drain to Source Voltage		150	V		
V <sub>GSS</sub>	Coto to Source Voltage	- DC	- DC		V	
	Gate to Source Voltage	- AC	(f > 1 Hz)	±30	v	
ID	Drain Current	- Continuous (T <sub>C</sub> = 25°C,	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C,Silicon Limited)		Α	
	Drain Current	- Continuous (T <sub>C</sub> = 100°C	- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C,Silicon Limited)			
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	104	А	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)			78	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		6.0	V/ns		
P <sub>D</sub>	Dower Dissinction	$(T_{\rm C} = 25^{\rm o}{\rm C})$		63	W	
	Power Dissipation	- Derate above 25°C		0.5	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

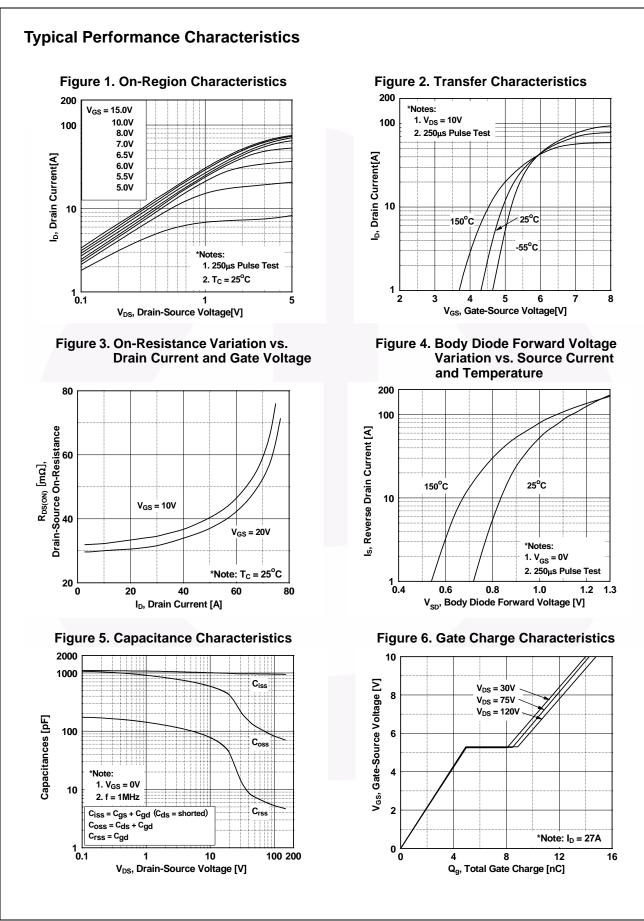
### **Thermal Characteristics**

Symbol	Parameter	FDD390N15A	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	2.0	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	87	°C/vv

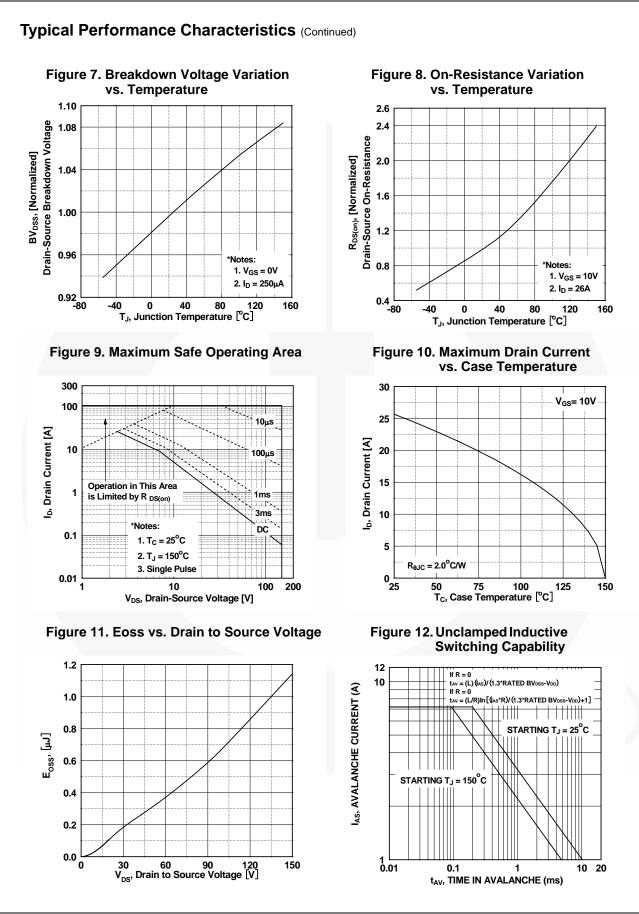
Part NumberTop MarkPackageFDD390N15AFDD390N15ADPAK		Package	Packing Method Reel Size   Tape and Reel 330 mm		Tape W	/idth	Quantity		
		DPAK			16 mm		2500 units		
Electrica	I Cha	racteristics T <sub>c</sub>	= 25ºC unless	otherwise noted					
Symbol		Parameter		Test Conc	litions	Min. Typ.		Max.	Unit
Off Charac	teristic	CS							
BV <sub>DSS</sub>	Drain t	Drain to Source Breakdown Voltage		$I_{D} = 250 \ \mu A, \ V_{GS} = 0 \ V$		150	-	-	V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient		iture	$I_D = 250 \ \mu\text{A}, \text{ Referenced to } 25^{\circ}\text{C}$		-	0.1	-	V/ºC
	Zero G	Zero Gate Voltage Drain Current		$V_{DS} = 120 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	
I <sub>DSS</sub> Zero Gate		te voltage Drain Current		$V_{DS} = 120 V, T_{C} = 125^{\circ}C$		-	-	500	μΑ
I <sub>GSS</sub>	Gate to	Gate to Body Leakage Current		$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$		-	-	±100	nA
On Charac	teristic	cs							
V <sub>GS(th)</sub>	Gate Threshold Voltage			$V_{GS} = V_{DS}, I_{D} = 250$	μA	2.0	-	4.0	V
R <sub>DS(on)</sub>		Drain to Source On Re				-	33.5	40	mΩ
9 <sub>FS</sub>	Forward Transconductance			$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 26 \text{ A}$		-	33	-	S
Dynamic C	haract	eristics							
C <sub>iss</sub>	-	Capacitance	-			-	965	1285	pF
C <sub>oss</sub>	Output	Capacitance		V <sub>DS</sub> = 75 V, V <sub>GS</sub> = 0 V f = 1 MHz		-	96	130	pF
C <sub>rss</sub>	Revers	se Transfer Capacitano	ce			-	5.8	-	pF
C <sub>oss(er)</sub>	Energy Related Output Capacitance		icitance	$V_{DS} = 75 V, V_{GS} = 0 V$			169	-	pF
Q <sub>g(tot)</sub>	Total G	Sate Charge at 10V		$V_{DS} = 75 \text{ V}, \text{ I}_{D} = 27 \text{ A}$ $V_{GS} = 10 \text{ V}$ (Note 4)		-	14.3	18.6	nC
Q <sub>gs</sub>	Gate to	o Source Gate Charge	1				5.0	-	nC
Q <sub>gs2</sub>	Gate C	Charge Threshold to Pl	ateau			-	2.0	-	nC
Q <sub>gd</sub>	Gate to	o Drain "Miller" Charge	;			-	3.5	-	nC
ESR	Equiva	lent Series Resistance	∋ (G-S)	f = 1 MHz		-	1.4	-	Ω
Switching	Charad	cteristics							
d(on)	-	n Delay Time	-				14	38	ns
t <sub>r</sub>	Turn-O	n Rise Time		$V_{DD}$ = 75 V, I <sub>D</sub> = 27 A V <sub>GS</sub> = 10 V, R <sub>GEN</sub> = 4.7 Ω		-	10	30	ns
t <sub>d(off)</sub>	Turn-O	off Delay Time				-	20	50	ns
t <sub>f</sub>	Turn-O	Turn-Off Fall Time		(Note 4)		-	5	20	ns
Drain-Sou	rce Dio	de Characteristi							
s		um Continuous Drain t		e Forward Current		-	_	26	A
s sм	Maximum Pulsed Drain to Source Diode F					-	-	104	Α
V <sub>SD</sub>	Drain to Source Diode Forward Voltage			$V_{GS} = 0 V, I_{SD} = 26 A$		-	- 7	1.25	V
t <sub>rr</sub>	Reverse Recovery Time		<u> </u>	$V_{GS} = 0 V, I_{SD} = 27 A, V_{DD} = 75 V$		-	63	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge			$dI_{F}/dt = 100 \text{ A}/\mu\text{s}$		-	131	-	nC

3. I\_{SD}  $\leq$  26 A, di/dt  $\leq$  200 A/µs, V\_{DD}  $\leq$  BV\_{DSS}, Starting T\_J = 25°C

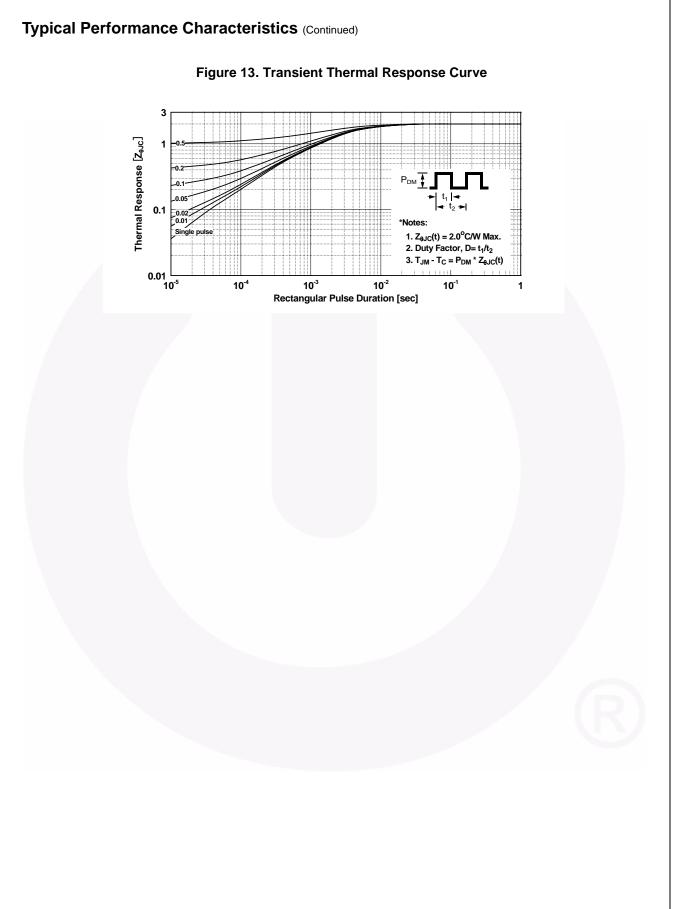
4. Essentially Independent of Operating Temperature Typical Characteristics

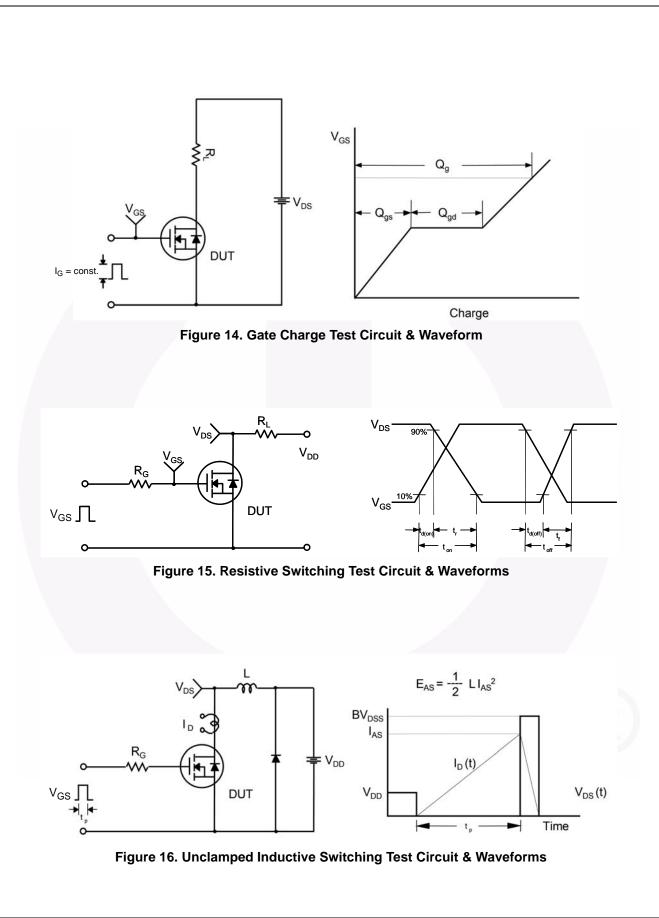


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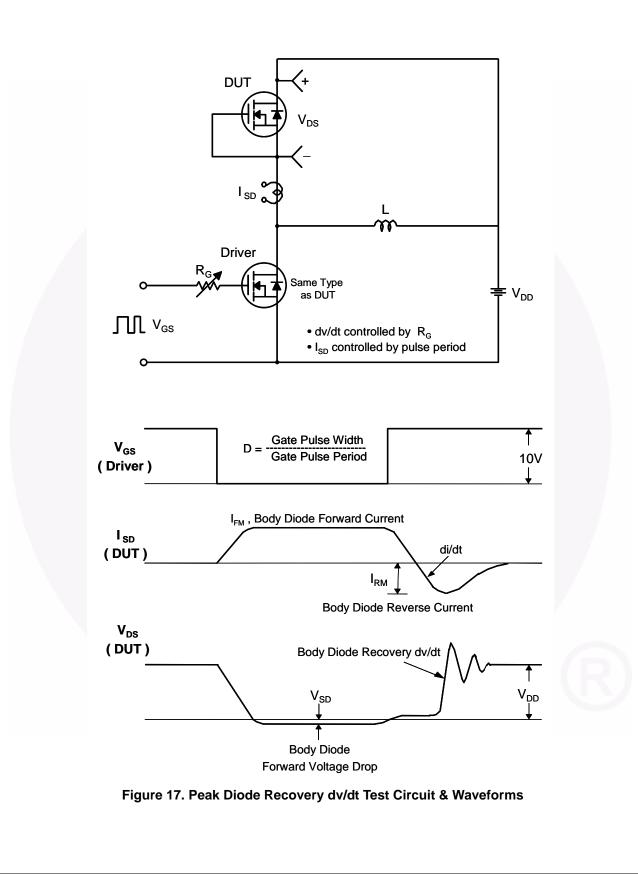
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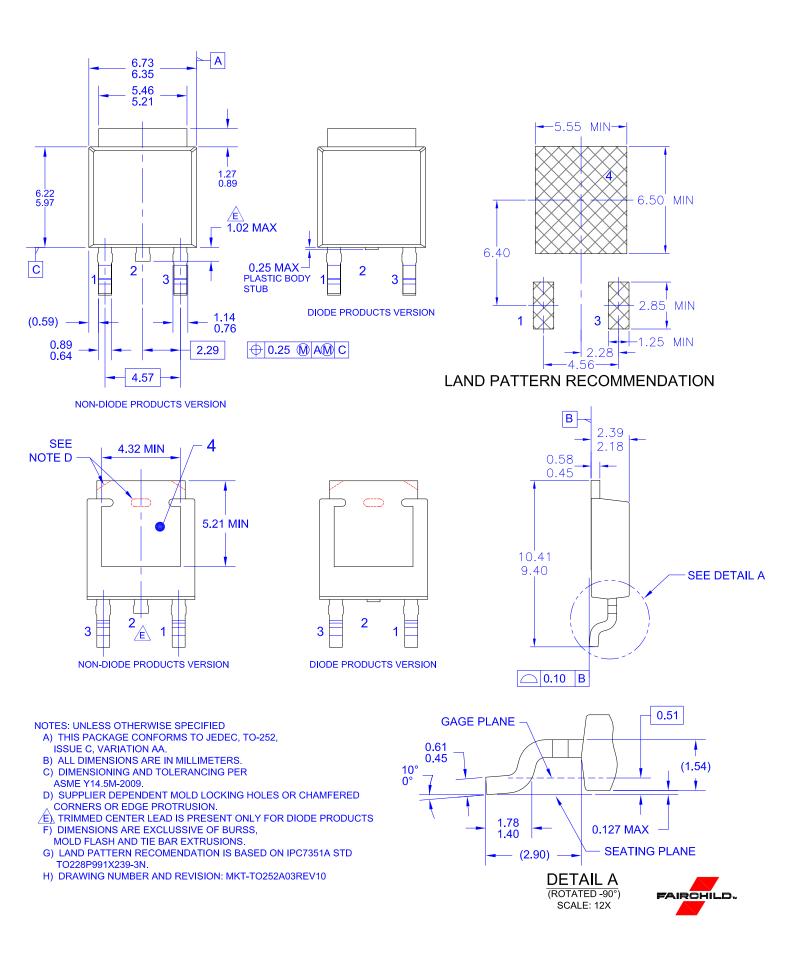


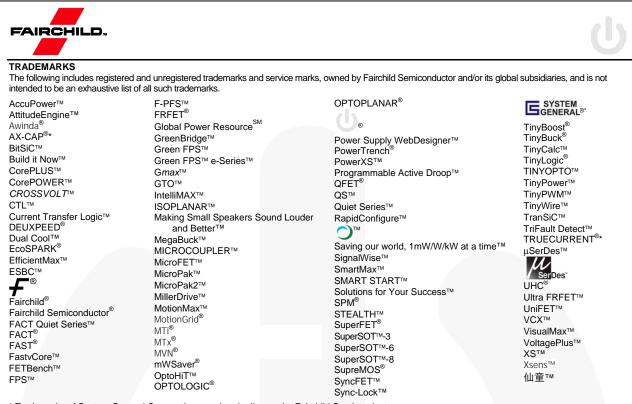


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